TOSHIBA Transistor Silicon NPN Epitaxial Planar Type (PCT process)

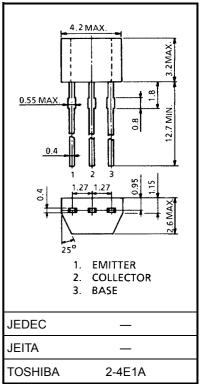
2SC2669

High Frequency Amplifier Applications

- High power gain: $G_{pe} = 30 dB (typ.) (f = 10.7 MHz)$
- Recommended for FM IF, OSC stage and AM CONV, IF stage.

Maximum Ratings (Ta = 25°C)

| Characteristics | Symbol | Rating | Unit |
|-----------------------------|------------------|---------|------|
| Collector-base voltage | V _{CBO} | 35 | V |
| Collector-emitter voltage | V _{CEO} | 30 | V |
| Emitter-base voltage | V _{EBO} | 4 | V |
| Collector current | Ι _C | 50 | mA |
| Base current | Ι _Β | 10 | mA |
| Collector power dissipation | P _C | 200 | mW |
| Junction temperature | Tj | 125 | °C |
| Storage temperature range | T _{stg} | -55~125 | °C |



Weight: 0.13 g (typ.)

Electrical Characteristics (Ta = 25°C)

| Characteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|--------------------------------------|----------------------------------|--|-----|------|-----|------|
| Collector cut-off current | I _{CBO} | $V_{CB} = 35 \text{ V}, \text{ I}_{E} = 0$ | | | 0.1 | μA |
| Emitter cut-off current | I _{EBO} | $V_{EB} = 4 V, I_C = 0$ | | _ | 1.0 | μA |
| DC current gain | h _{FE} (Note) | $V_{CE} = 12 V, I_{C} = 2 mA$ | 40 | _ | 240 | |
| Collector-emitter saturation voltage | V _{CE (sat)} | $I_{\rm C} = 10 \text{ mA}, I_{\rm B} = 1 \text{ mA}$ | | | 0.4 | V |
| Base-emitter voltage | V _{BE} | I _C = 10 mA, I _B = 1 mA | | — | 1.0 | V |
| Transition frequency | f _T | $V_{CE} = 10 \text{ V}, \text{ I}_{C} = 1 \text{ mA}$ | 100 | — | _ | MHz |
| Collector output capacitance | C _{ob} | $V_{CB} = 10 \text{ V}, \text{ I}_{E} = 0, \text{ f} = 1 \text{ MHz}$ | _ | 2.0 | 3.2 | pF |
| Collector-base time constant | C _c .r _{bb'} | $V_{CE} = 10 \text{ V}, \text{ I}_{E} = -1 \text{ mA}, \text{ f} = 30 \text{ MHz}$ | _ | | 50 | ps |
| Power gain | G _{pe} | V _{CC} = 6 V, I _E = -1 mA, f = 10.7 MHz (Figure 1) | 27 | 30 | 33 | dB |

Note: hFE classification R: 40~80, O: 70~140, Y: 120~240

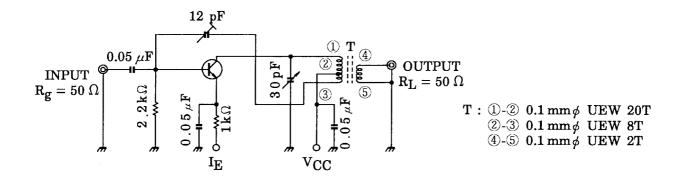


Figure 1 G_{pe} Test Circuit

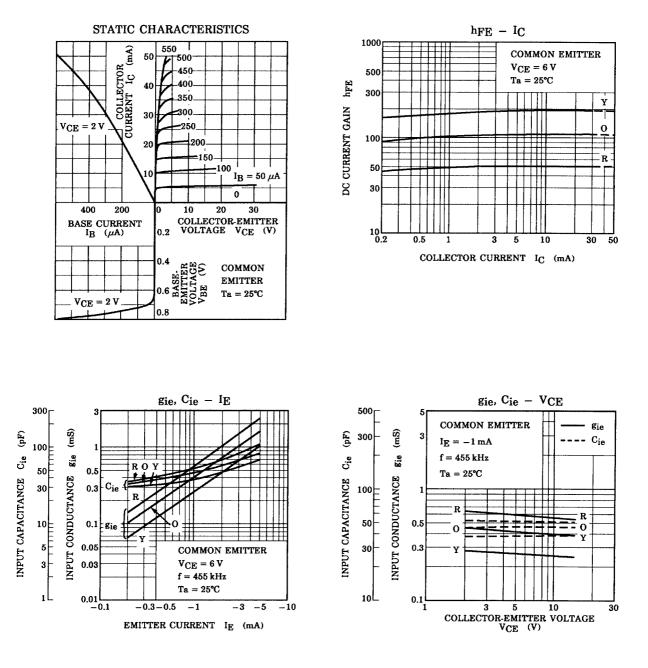
Y Parameters (typ.)

(1) (common emitter f = 455 kHz, $Ta = 25^{\circ}C$)

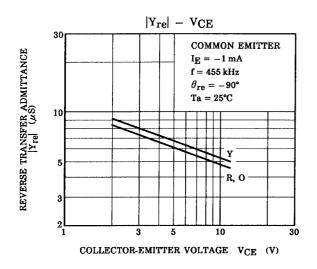
| Characteristics | Symbol | 2SC2669-R | 2SC2669-O | 2SC2669-Y | Unit |
|--|-----------------|-----------|-----------|-----------|------|
| Collector-emitter voltage | V _{CE} | 6 | 6 | 6 | V |
| Emitter current | ΙE | -1 | -1 | -1 | mA |
| Input conductance | gie | 0.58 | 0.41 | 0.26 | mS |
| Input capacitance | C _{ie} | 53 | 46 | 38 | pF |
| Output conductance | goe | 1.9 | 2.7 | 4.8 | μS |
| Output capacitance | C _{oe} | 2.6 | 2.8 | 3.6 | pF |
| Forward transfer admittance | y _{fe} | 38 | 38 | 38 | mS |
| Phase angle of forward transfer admittance | θ _{fe} | -0.79 | -0.83 | -0.92 | o |
| Reverse transfer admittance | y _{re} | 5.7 | 5.7 | 6.2 | μS |
| Phase angle of reverse transfer admittance | θ _{re} | -90 | -90 | -90 | o |

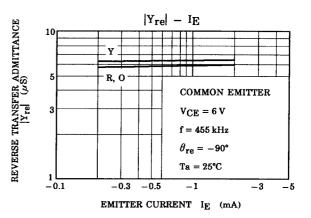
(2) (common emitter f = 10.7 MHz, Ta = 25°C)

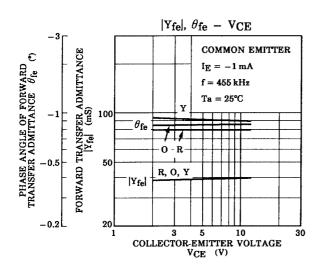
| Characteristics | Symbol | 2SC2669-R | 2SC2669-O | 2SC2669-Y | Unit |
|--|-----------------|-----------|-----------|-----------|------|
| Collector-emitter voltage | V _{CE} | 6 | 6 | 6 | V |
| Emitter current | ١ _E | -1 | -1 | -1 | mA |
| Input conductance | gie | 1.04 | 0.85 | 0.65 | mS |
| Input capacitance | C _{ie} | 49 | 43 | 36 | pF |
| Output conductance | goe | 10 | 15 | 28 | μS |
| Output capacitance | C _{oe} | 2.7 | 2.9 | 3.6 | pF |
| Forward transfer admittance | y _{fe} | 37 | 37 | 37 | mS |
| Phase angle of forward transfer admittance | θ _{fe} | -9.6 | -10.4 | -11.5 | o |
| Reverse transfer admittance | y _{re} | 120 | 120 | 140 | μS |
| Phase angle of reverse transfer admittance | θ _{re} | -90 | -90 | -90 | 0 |

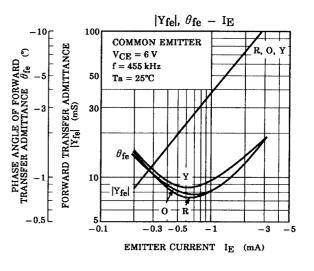


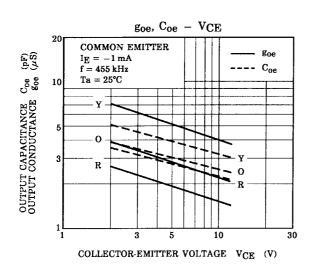
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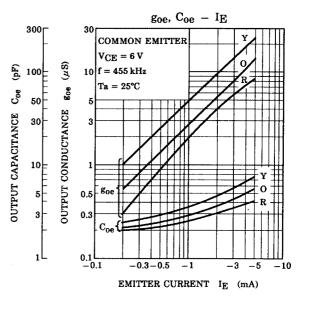




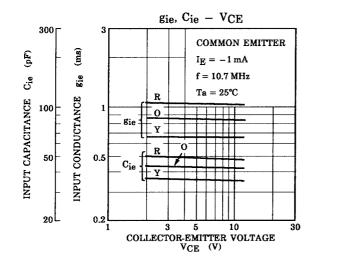


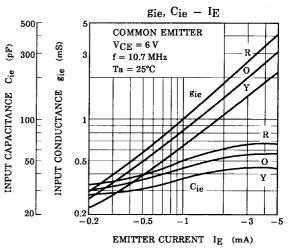


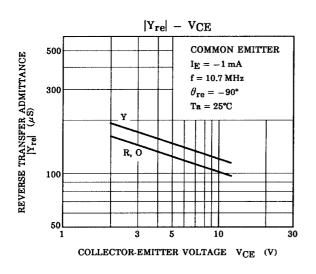


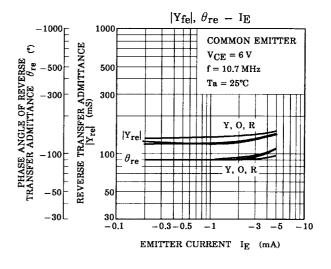


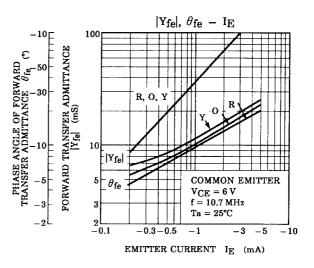
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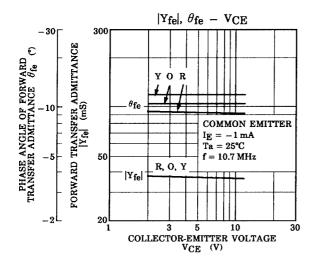




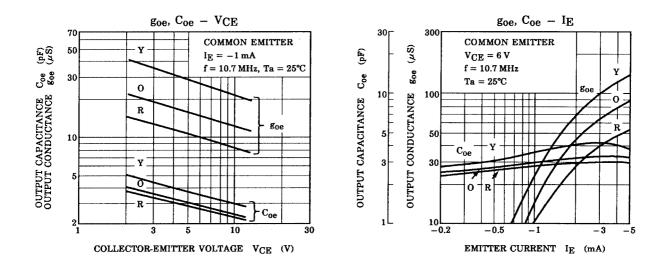


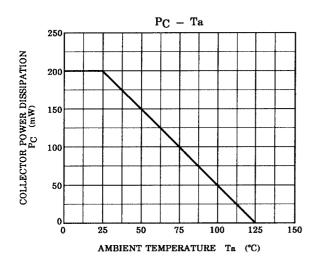






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